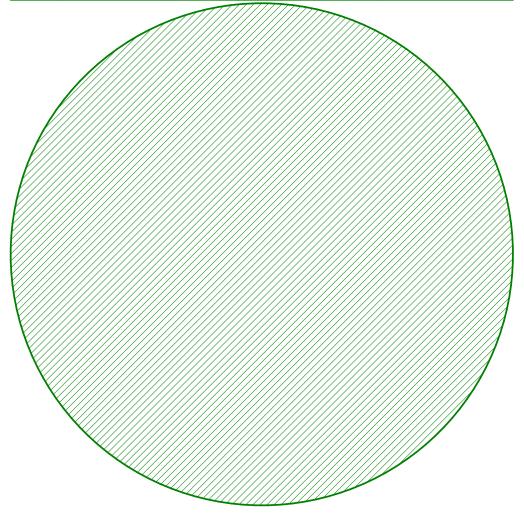


Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	SM-001	1.00mil	4	
1	Top Layer	Copper	1.38mil		
	Dielectric 1	PP-017	5.10mil	4.3	
	Dielectric 2	PP-017	5.10mil	4.3	
2	Int1 (GND)	Copper	1.38mil		
	Dielectric 3	Core-039	28.00mil	4.8	
3	Int2 (PWR)	Copper	1.38mil		
	Dielectric 4	PP-017	5.10mil	4.3	
	Dielectric 5	PP-017	5.10mil	4.3	
4	Bottom Layer	Copper	1.38mil		
	Bottom Solder	SM-001	1.00mil	4	
	Bottom Overlay				



## Board Stack Report